| Ref<br># | Hits | Search Query                                                                                 | DBs                                                               | Default<br>Operator | Plurals | Time Stamp       |
|----------|------|----------------------------------------------------------------------------------------------|-------------------------------------------------------------------|---------------------|---------|------------------|
| L1       | 956  | solder near (mold or transfer)                                                               | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR                  | ON      | 2005/09/21 07:35 |
| L2       | 306  | 1 and mold                                                                                   | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR                  | ON      | 2005/09/21 07:35 |
| L3       | 184  | 2 and (press\$4 or compress\$4)                                                              | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR                  | ON      | 2005/09/21 07:36 |
| L4       | 159  | 3 and (heat\$4 or reflow\$4 or melt\$4)                                                      | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR                  | ON      | 2005/09/21 07:36 |
| L5       | 126  | 4 and plate\$3                                                                               | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR                  | ON      | 2005/09/21 07:39 |
| L6       | 1    | 5 and (thermal\$4 adj ductile or<br>thermal\$4 near buffer or solder<br>near (plug or slug)) | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR                  | ON      | 2005/09/21 07:44 |
| L7       | 1    | 2 and (thermal\$4 adj ductile or<br>thermal\$4 near buffer or solder<br>near (plug or slug)) | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR                  | ON      | 2005/09/21 07:44 |
| L8       | 1    | ("6003757").PN.                                                                              | USPAT                                                             | OR                  | OFF     | 2005/09/21 07:41 |

| Ref<br># | Hits | Search Query                                                                                 | DBs                                                               | Default<br>Operator | Plurals | Time Stamp       |
|----------|------|----------------------------------------------------------------------------------------------|-------------------------------------------------------------------|---------------------|---------|------------------|
| L1       | 956  | solder near (mold or transfer)                                                               | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR                  | ON      | 2005/09/21 07:35 |
| L2       | 306  | 1 and mold                                                                                   | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR                  | ON      | 2005/09/21 07:35 |
| L3       | 184  | 2 and (press\$4 or compress\$4)                                                              | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR                  | ON      | 2005/09/21 07:36 |
| L4       | 159  | 3 and (heat\$4 or reflow\$4 or melt\$4)                                                      | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR                  | ON      | 2005/09/21 07:36 |
| L5       | 126  | 4 and plate\$3                                                                               | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR                  | ON      | 2005/09/21 07:46 |
| L6       | 1    | 5 and (thermal\$4 adj ductile or<br>thermal\$4 near buffer or solder<br>near (plug or slug)) | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR                  | ON      | 2005/09/21 07:44 |
| L7       | 1    | 2 and (thermal\$4 adj ductile or<br>thermal\$4 near buffer or solder<br>near (plug or slug)) | US-PGPUB;<br>USPAT;<br>USOCR;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR                  | ON      | 2005/09/21 07:44 |
| L8       | 1    | ("6003757").PN.                                                                              | USPAT                                                             | OR                  | OFF     | 2005/09/21 07:41 |